

ON Semiconductor®

FDS8984-F085

N-Channel PowerTrench[®] MOSFET 30V, 7A, 23m Ω

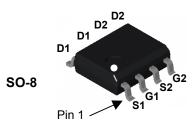
General Description

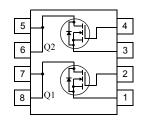
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{\text{DS(ON)}}$ and fast switching speed.

Features

- Max $r_{DS(on)} = 23m\Omega$, $V_{GS} = 10V$, $I_D = 7A$
- Max $r_{DS(on)} = 30m\Omega$, $V_{GS} = 4.5V$, $I_D = 6A$
- Low gate charge
- 100% R_G tested
- Qualified to AEC Q101
- RoHS Compliant







MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

| Symbol | Parameter | | Ratings | Units |
|-----------------------------------|--|-------|------------|-------|
| V_{DS} | Drain to Source Voltage | | 30 | V |
| V_{GS} | Gate to Source Voltage | | ±20 | V |
| | Drain Current Continuous (Not | e 1a) | 7 | Α |
| ID | Pulsed | | 30 | Α |
| E _{AS} | Single Pulse Avalache Energy (Note | 2) | 32 | mJ |
| D | Power Dissipation for Single Operation | | 1.6 | W |
| P_{D} | Derate above 25°C | | 13 | mW/°C |
| T _J , T _{STG} | Operating and Storage Temperature | | -55 to 150 | °C |

Thermal Characteristics

| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | (Note 1a) | 78 | °C/W |
|-----------------|---|-----------|----|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | (Note 1) | 40 | °C/W |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|--------------|---------|-----------|------------|------------|
| FDS8984 | FDS8984-F085 | SO-8 | 330mm | 12mm | 2500 units |

Max

Тур

Min

Units

Electrical Characteristics T_J = 25°C unless otherwise noted

Parameter

| Off Char | acteristics | | | | | |
|--------------------------------------|---|--|----|----|----------|-------|
| BV _{DSS} | Drain to Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0 V$ | 30 | | | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature Coefficient | I _D = 250μA, referenced to 25°C | | 23 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 24V$ $V_{GS} = 0V$ $T_{J} = 125^{\circ}C$ | | | 1 250 | μΑ |
| I _{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 20 V, V_{DS} = 0 V$ | | | ±100 | nA |

Test Conditions

On Characteristics (Note 3)

Symbol

| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 1.2 | 1.7 | 2.5 | V |
|--|---|---|-----|-------|-----|-------|
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate to Source Threshold Voltage Temperature Coefficient | I_D = 250 μ A, referenced to 25°C | | - 4.3 | | mV/°C |
| | Drain to Source On Resistance | $V_{GS} = 10V, I_D = 7A$ | | 19 | 23 | |
| rno. | | $V_{GS} = 4.5V, I_D = 6A$ | | 24 | 30 | mΩ |
| r _{DS(on)} | Brain to Godree Off Resistance | $V_{GS} = 10V, I_D = 7A,$ $T_J = 125^{\circ}C$ | | 26 | 32 | 11152 |

Dynamic Characteristics

| C _{iss} | Input Capacitance | \\ -45\\\\ -0\\ | 475 | 635 | pF |
|------------------|------------------------------|--|-----|-----|----|
| C _{oss} | Output Capacitance | V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz | 100 | 135 | pF |
| C _{rss} | Reverse Transfer Capacitance | - 1.0WH12 | 65 | 100 | pF |
| R_G | Gate Resistance | f = 1MHz | 0.9 | 1.6 | Ω |

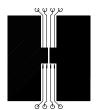
Switching Characteristics (Note 3)

| t _{d(on)} | Turn-On Delay Time | | 5 | 10 | ns |
|---------------------|-------------------------------|---|-----|----|----|
| t _r | Rise Time | V _{DD} = 15V, I _D = 7A | 9 | 18 | ns |
| t _{d(off)} | Turn-Off Delay Time | V_{GS} = 10V, R_{GS} = 33 Ω | 42 | 68 | ns |
| t _f | Fall Time | | 21 | 34 | ns |
| Q_g | Total Gate Charge | $V_{DS} = 15V, V_{GS} = 10V,$ $I_{D} = 7A$ | 9.2 | 13 | nC |
| Q_g | Total Gate Charge | $V_{DS} = 15V, V_{GS} = 5V,$ | 5.0 | 7 | nC |
| Q _{gs} | Gate to Source Gate Charge | I _D = 7A | 1.5 | | nC |
| Q_{gd} | Gate to Drain "Miller" Charge | | 2.0 | | nC |

Drain-Source Diode Characteristics

| ., | 0 | I _{SD} = 7A | T | 0.9 | 1.25 | V |
|-----------------|-------------------------------|--------------------------------------|---|-----|------|----|
| V_{SD} | Source to Drain Diode Voltage | I _{SD} = 2.1A | | 0.8 | 1.0 | V |
| t _{rr} | Diode Reverse Recovery Time | I _F = 7A, di/dt = 100A/μs | | | 33 | ns |
| Q _{rr} | Diode Reverse Recovery Charge | | | | 20 | nC |

¹³ R_{0,IA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0,IC} is guaranteed by design while R_{0,CA} is determined by the user's board design.



a) 78°C/W when mounted on a 0.5in^2 pad of 2 oz copper



ယ္မှ*မွ* b) 125°C/W when mounted on a 0.02 in² pad of oz copper



c) 135°C/W when mounted on a mounted on a minimun pad



Scale 1: 1 on letter size paper

- 2: Starting T $_J$ = 25°C, L = 1mH, I $_{AS}$ = 8A, V $_{DD}$ = 27V, V $_{GS}$ = 10V. 3: Pulse Test:Pulse Width <300 μ S, Duty Cycle <2%.

Typical Characteristics T_J = 25°C unless otherwise noted

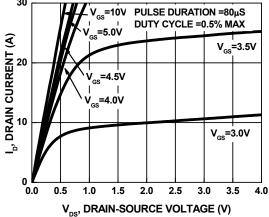


Figure 1. On Region Characteristics

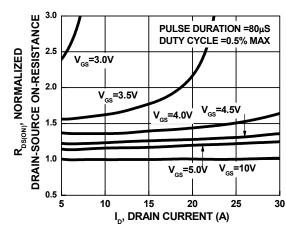


Figure 2. On-Resistance vs Drain Current and Gate Voltage

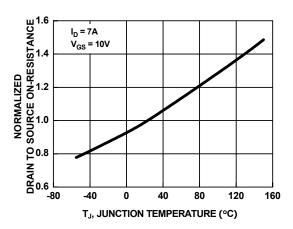


Figure 3. On Resistance vs Temperature

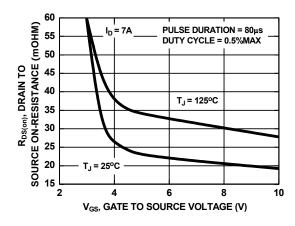
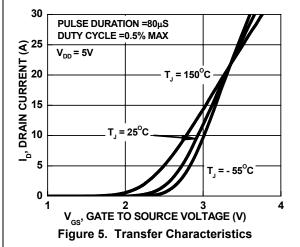


Figure 4. On-Resistance vs Gate to Source Votlage



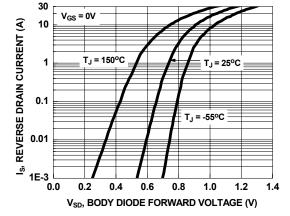


Figure 6. Source to Drain Diode Forward Voltage vs Source Current



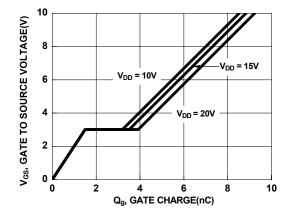


Figure 7. Gate Charge Characteristics

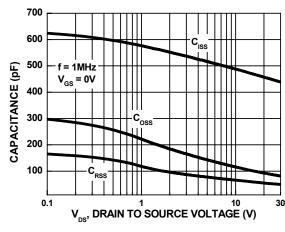


Figure 8. Capacitance vs Drain to Source Voltage

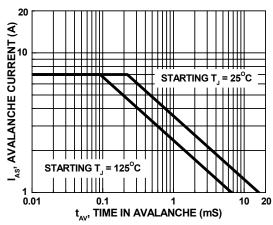


Figure 9. Unclamped Inductive Switching Capability

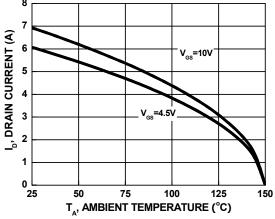


Figure 10. Maximum Continuous Drain Current vs
Ambient Temperature

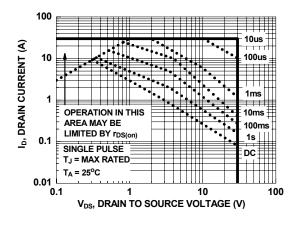


Figure 11. Forward Bias Safe Operating Area

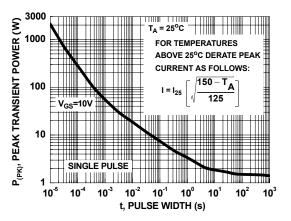


Figure 12. Single Pulse Maximum Power Dissipation

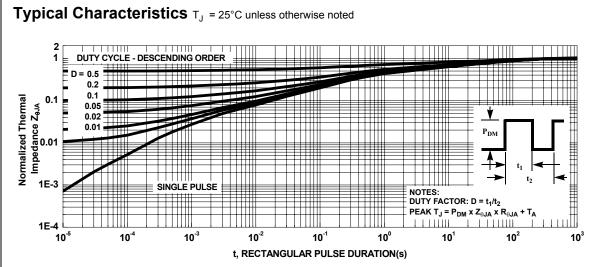


Figure 13. Transient Thermal Response Curve

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